# MSKSEMI 美森科













**ESD** 

MOV

GDT

PIFD

# MB05S THRU MB10S

**Product specification** 





#### **Features**

- Ideal for printed circuit board
- Reliable low cost construction utilizing molded plastic technique
- High temperature soldering guaranteed: 260<sub>°</sub> /10 seconds at 5 lbs., (2.3kg) tension
- Small size, simple installation
- High surge current capability

#### **Mechanical Data**

Case: JEDEC MBS Molded plastic body

Terminals: Solder plated, solderable per MIL-STD-750, Method 2026

Polarity: Polarity symbol marking on body

Mounting Position: Any

Weight: 0.008 ounce, 0.22 grams

## **Maximum Ratings And Electrical Characteristics**

Ratings at 25. C ambient temperature unlss otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter		MB05S	MB1S	MB2S	MB4S	MB6S	MB8S	MB10S	UNITS
Marking Code	SYMBOLS								
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at Tc=30℃ On glass-epoxy P.C.B.  On aluminum substrate	l <sub>F(AV)</sub>				0.5 0.8				А
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>				30				А
Maximum instantaneous forward voltage drop per leg at=0	).4A V <sub>F</sub>				1.0				V
	lR				5 0.5				uA mA
Typical junction capacitance (Note 3)	Cı	13			PF				
Typical thermal resistance	Rejc				70				°C/W
Operating temperature range	TJ			-5	5 to +150	)			°C
storage temperature range	Тѕтс			-5	5 to +150	)			°C

#### NOTES:

<sup>1.</sup>On glass epoxy P.C.B. mounted on 0.05x0.05"(1.3x1.3mm) pads

<sup>2.</sup>On aluminum substrate P.C.B. with on area of 0.8":v0.8"(20x20mm) mounted on 0.05X0.05"(1.3X1.3mm) solder pad 3.Measured at 1.0MHz and applied reverse voltage of 4.0 volts.



## **Ratings And Characteristic Curves**

Fig.1 Average Rectified Output Current Derating Curve

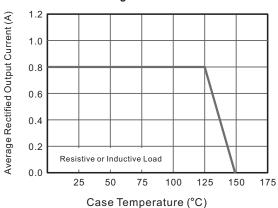


Fig.2 Typical Reverse Characteristics

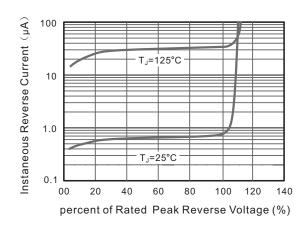


Fig.3 Typical Instaneous Forward Characteristics

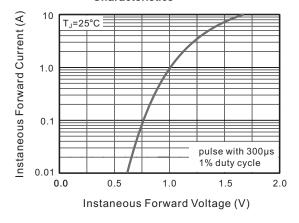


Fig.4 Typical Junction Capacitance

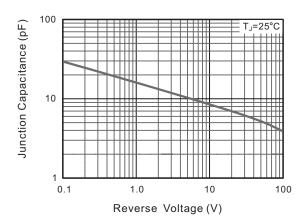
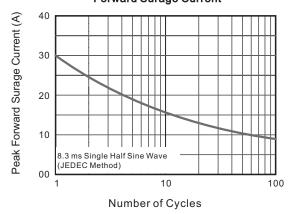


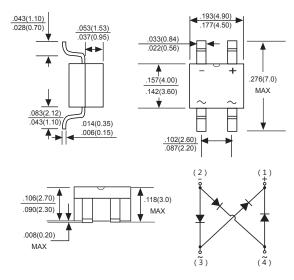
Fig.5 Maximum Non-Repetitive Peak Forward Surage Current



The curve above is for reference only.

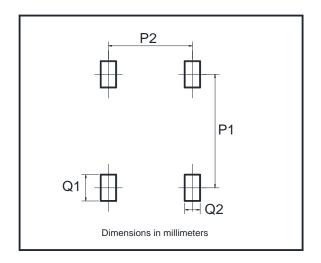


#### PACKAGE MECHANICAL DATA



Dimensions in inches and (millimeters)

## **Suggested Pad Layout**



Dim	Min
Dilli	IVIIII
P1	6.00
P2	2.40
Q1	1.84
Q2	1.20

## **REEL SPECIFICATION**

P/N	PKG	QTY
MB05S THRU MB10S	MB05S THRU MB10S MBS	



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